

Appl. No. 09/694,927
Amdt. Dated 12 November, 2003
Reply to Office Action of Sept. 12, 2003

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claim 1 (currently amended): A frozen food product, comprising; at least one unleavened baked wafer, wherein the baked wafer is molded into a desired shape prior to baking exhibiting high resistance to moisture while retaining crispiness having opposed major surfaces, a thickness, and a moisture content of about 2% to no greater than about 5%, fabricated from a dough or batter composition, comprising: flour, water and a sweetener, wherein the sweetener ~~comprises~~ consists of sucrose, and at least 40% of a member of the group consisting of at least one a high molecular weight starch hydrolysate having a DE of 1 to 20 or a crystalline hydrate former, wherein the crystalline hydrate former is selected from the group consisting of maltose, trehalose, isomalt, and raffinose, and mixtures thereof; having a modulus of at least 200 g/mm² at a moisture content of 9%; and a frozen dessert composition in contact with at least one major wafer surface.

Claim 2 (currently amended): The frozen food product of claim 1, wherein the ~~The~~ baked wafer has of claim 1, having a modulus of at least 300 g/mm² at a moisture content of 9%.

Claim 3 (currently amended): The frozen food product of claim 1, wherein the ~~The~~ baked wafer of claim 1, wherein the sweetener of the baked wafer comprises at least one

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of the high molecular weight starch hydrolysate and the crystalline hydrate former, and
sucrose.

Claims 4-6 (canceled)

Claim 7 (currently amended): The frozen food product ~~The baked wafer~~ of claim 1,
wherein the high molecular weight starch hydrolysate of the baked wafer is corn syrup
solids having a DE of 1 to 20.

Claim 8 (canceled)

Claim 9 (currently amended): The frozen food product of claim 1, wherein the ~~The~~
~~baked wafer of claim 1, having~~ has a modulus of at least 350 g/mm² at a moisture content
of 10%.

Claims 10-24 (canceled)

Claim 25 (currently amended): The frozen food product ~~dessert composition~~ of claim 1,
wherein the frozen dessert composition is selected from the group consisting of ice
cream, ice milk, gelato, frozen yogurt, sorbet, frozen custard, and sherbet.

Claim 26 (currently amended): The frozen food product of claim 1, wherein the ~~The~~
~~baked wafer of claim 1, wherein the wafer~~ is in the form of a cone.

Claim 27 (canceled)

Claim 28 (currently amended): The frozen food product of claim 1, wherein the ~~The~~
~~baked wafer of claim 1, wherein the wafer~~ is in the form of a flat wafer.

Claim 29 (currently amended): The flat wafer of claim 28, wherein the wafer is in the
form of a ~~disk~~ a cookie.

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Claim 30 (currently amended): The frozen food product of claim 1, wherein the

~~baked wafer of claim 1, wherein the wafer is curved in the form of a molded cup.~~

Claim 31 (currently amended): The frozen food product of claim 1, wherein the

~~baked wafer of claim 1, wherein the wafer is in the form of a cylinder forming a shell.~~

Claim 32 (currently amended): The frozen dessert composition food product of claim 25,

wherein the baked good is mixed throughout the frozen dessert composition.

Claim 33 (new): The frozen food product of claim 1, wherein the baked wafer

additionally comprises lecithin, salt, and shortening.